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[UH2B-E3/5BT](#)

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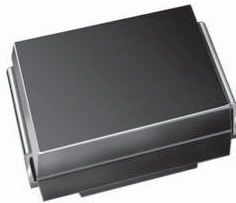


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UH2B, UH2C, UH2D

Vishay General Semiconductor

Surface Mount Ultrafast Rectifier



DO-214AA (SMB)

FEATURES

- Low profile package
- Ideal for automated placement
- Oxide planar chip junction
- Ultrafast recovery times for high frequency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds of AC/AC and DC/DC converters in high temperature conditions for both consumer and automotive applications.

MECHANICAL DATA

Case: DO-214AA (SMB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS compliant, commercial grade

Base P/NHE3 - RoHS compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
V_{RRM}	100 V, 150 V, 200 V
I_{FSM}	50 A
t_{rr}	25 ns
V_F at $I_F = 2.0$ A	0.69 V
T_J max.	175 °C

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)					
PARAMETER	SYMBOL	UH2B	UH2C	UH2D	UNIT
Device marking code		HB	HC	HD	
Maximum repetitive peak reverse voltage	V_{RRM}	100	150	200	V
Maximum average forward rectified current (fig. 1) ⁽¹⁾	$I_{F(AV)}$	2.0			A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	50			A
Operating junction and storage temperature range	T_J, T_{STG}	- 55 to + 175			°C

Note

⁽¹⁾ Free air, mounted on recommended copper pad area



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.79	-	V
	I _F = 2.0 A			0.87	1.05	
	I _F = 1.0 A	T _A = 125 °C		0.62	-	
	I _F = 2.0 A			0.69	0.90	
Reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	2.0	μA
		T _A = 125 °C		10	50	
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A	T _A = 25 °C	t _{rr}	15	25	ns
Typical reverse recovery time	I _F = 1.0 A, di/dt = 50 A/μs, V _R = 30 V, I _{rr} = 0.1 I _{RM}			20	35	
Typical softness factor (t _b /t _a)	I _F = 2.0 A, di/dt = 200 A/μs, V _R = 200 V	T _A = 125 °C	S	0.3	-	
Typical reverse recovery current			I _{RM}	5.0	6.0	A
Typical stored charge			Q _{rr}	55	-	nC
Typical junction capacitance	4.0 V, 1 MHz		C _J	42	-	pF

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	UH2B	UH2C	UH2D	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾	105			°C/W
	R _{θJM} ⁽¹⁾	15			

Note

(1) Free air, mounted on recommended copper pad area. Thermal resistance R_{θJA} - junction to ambient, R_{θJM} - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
UH2D-E3/52T	0.100	52T	750	7" diameter plastic tape and reel
UH2D-E3/5BT	0.100	5BT	3200	13" diameter plastic tape and reel
UH2DHE3/52T ⁽¹⁾	0.100	52T	750	7" diameter plastic tape and reel
UH2DHE3/5BT ⁽¹⁾	0.100	5BT	3200	13" diameter plastic tape and reel

Note

(1) AEC-Q 101 qualified



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RATINGS AND CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

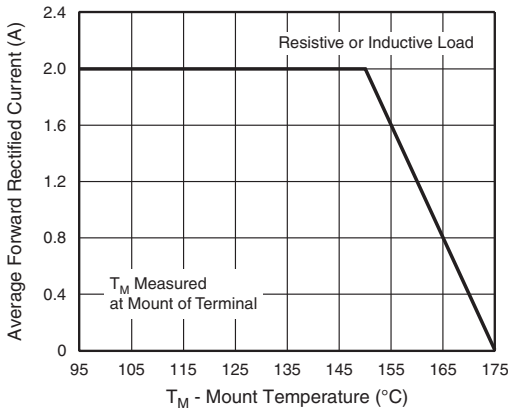


Fig. 1 - Maximum Forward Current Derating Curve

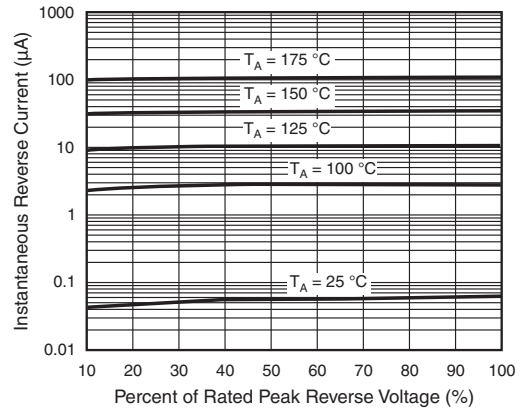


Fig. 4 - Typical Reverse Characteristics

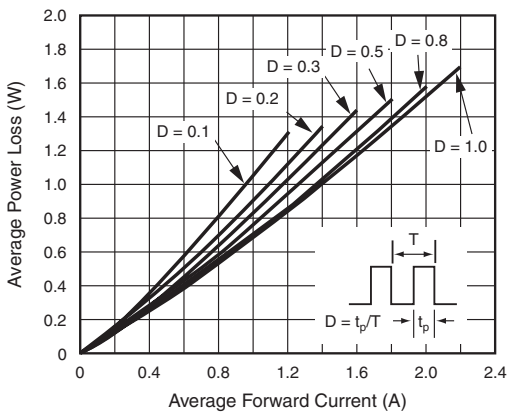


Fig. 2 - Forward Power Loss Characteristics

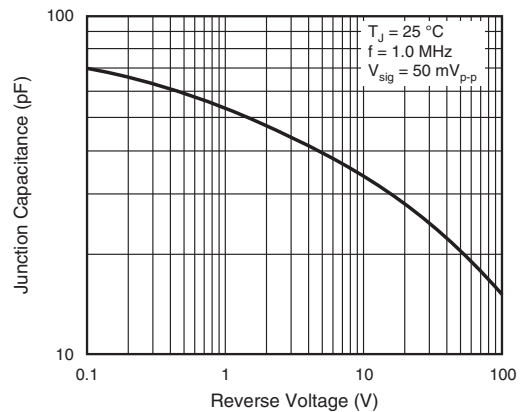


Fig. 5 - Typical Junction Capacitance

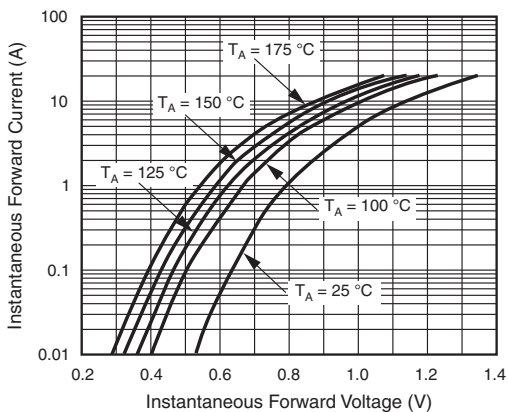


Fig. 3 - Typical Instantaneous Forward Characteristics

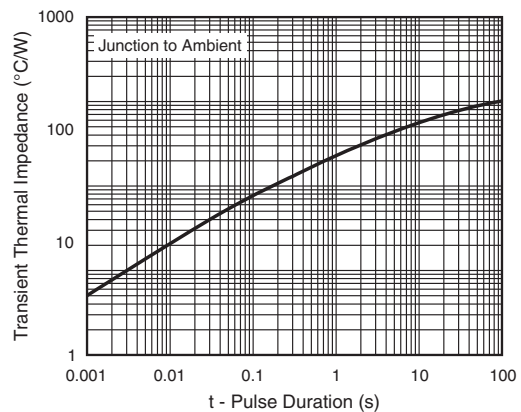


Fig. 6 - Typical Transient Thermal Impedance



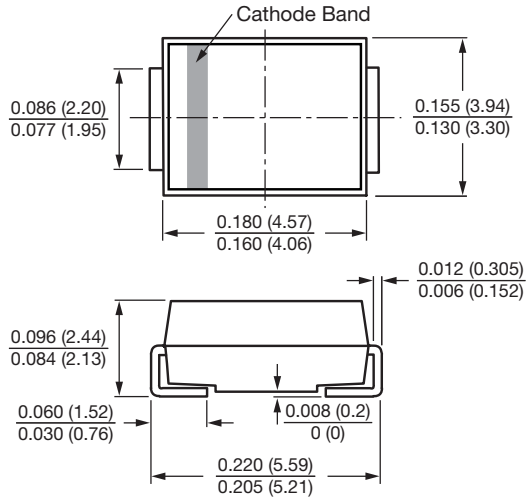
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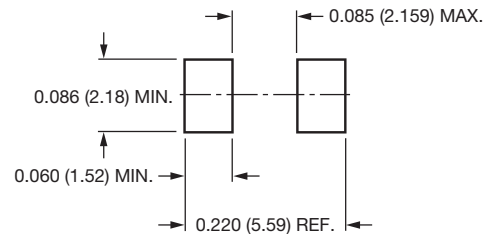
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AA (SMB)



Mounting Pad Layout





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